

## COPPER-INVAR-COPPER CLAD + METAL FOIL

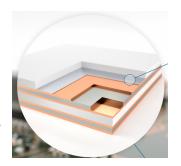




Copper-Invar-Copper clad has been introduced into the PCB industry to reinforce the PCB and control expansion, especially in high temperature environments and CTE mismatches when different materials are joined together. Foil is perfect for soldering because of its pureness. It fits tailormate to your requirements.

## **Advantages:**

- Minimizing thermal expansion coefficient and connecting similar materials
- > Low thermal coefficient
- > Thermal management
- > Superior dimensional stability



## **PORTFOLIO WICKEDER GROUP**

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